

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









Smart Technology. Delivered.™

## DA PowerCool Series DA-044-12-02

### Thermoelectric Assembly



Americas: +1.919.597.7300 Europe: +46.31.420530 Asia: +86.755.2714.1166 ets.sales@lairdtech.com www.lairdtech.com The DA PowerCool Series is a Direct-to-Air thermoelectric assembly (TEA) that uses impingement flow to transfer heat. It offers dependable, compact performance by cooling objects via conduction. Heat is absorbed through a cold plate and dissipated thru a high density heat exchanger equipped with an air ducted shroud and brand name fan. The thermoelectric modules are custom designed to achieve a high coefficient of performance (COP) to minimize power consumption. This product series is available in a wide range of cooling capacities and voltages. Custom configurations and moisture protection options are available, however, MOQ applies.

#### **FEATURES**

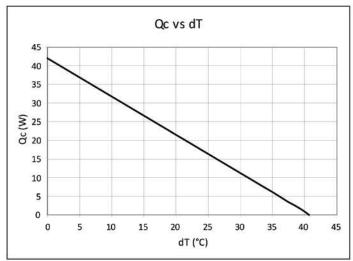
- Compact design
- Precise temperature control
- Reliable solid-state operation
- DC operation
- RoHS compliant

#### **APPLICATIONS**

- Analytical instrumentation
- Medical diagnostics
- Photonics laser systems
- Industrial instrumentation
- · Food and beverage cooling

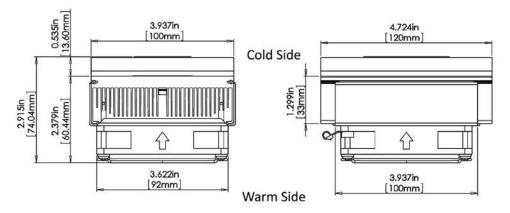
SPECIFICATIONS		
Cooling Power Qcmax (W)	42	
Running Current (A)	3.8	
Startup Current (A)	4.7	
Nominal Voltage (V)	12	
Max Voltage (V)	15	
Power Input (W)	46	
Operating Temperature (°C)	-10 to 46	
Weight (kg)	0.6	
MTBF (fans - hrs)	50,000	
Performance Tolerance	±10%	

#### **PERFORMANCE CURVE**



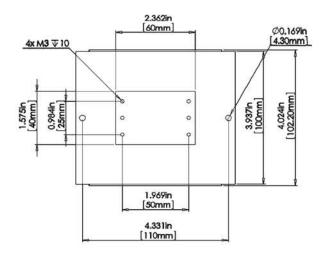


#### ISOMETRIC DRAWINGS



#### **MOUNTING HOLE LOCATION**

# WIRING SCHEMATIC



**Electrical connections** 

TEM+: Orange TEM-: White Fan+: Purple Fan-: Blue

#### **NOTES**

For indoor use only

Thermally conductive grease enclosed

#### LAIRD-ETS-DA-044-12-02-DATA-SHEET-100616

Any information furnished by Laird Technologies, Inc. and its agents is believed to be accurate and reliable. All specifications are subject to change without notice. Responsibility for the use and application of Laird Technologies materials rests with the end user. Laird Technologies makes no warranties as to the fitness, merchantability, suitability or non- infringement of any Laird Technologies materials or products for any specific or general uses. Laird Technologies shall not be liable for incidental or consequential damages of any kind. All Laird Technologies products are sold pursuant to the Laird Technologies' Terms and Conditions of sale in effect from time to time, a copy of which will be furnished upon request. © Copyright 2016 Laird Technologies, Inc. All Rights Reserved. Laird, Laird Technologies, the Laird Technologies Logo, and other marks are trademarks or registered trademarks of Laird Technologies, Inc. or an affiliate company thereof. Other product or service names may be the property of third parties. Nothing herein provides a license under any Laird Technologies or any third party intellectual property rights.